2 Line USB 1.1 Upstream EMI Filter

This device is a 2 line EMI filter array for USB port protection in wireless applications. Greater than -20 dB attenuation is obtained at frequencies from 900 MHz to 3.0 GHz. It also has 2 lines for dedicated ESD protection. ESD protection is provided across all capacitors.

Features

- EMI Filtering and ESD Protection
- Integration of 10 Discretes
- Provides Protection for IEC61000–4–2 (Level 4)
 - 15 kV (Contact)
- Flip-Chip Package
- Moisture Sensitivity Level 1
- ESD Rating: Machine Model = C; Human Body Model = 3B

Benefits

- Reduces EMI/RFI Emissions on a Data Line
- Integrated Solution Offers Cost and Space Savings
- Reduces Parasitic Inductances Which Offer a More "Ideal" Low Pass Filter Response
- Integrated Solution Improves System Reliability
- This is a Pb–Free Device

Applications

- EMI Filtering and ESD Protection for Data Lines
- Cell Phones
- Handheld Products
- Notebook Computers
- MP3 Players

MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise noted)

Rating		Symbol	Value	Unit	
ESD Discharge IEC61000-4-2	Contact Discharge	V _{PP}	15	kV	
Operating Temperatur	T _{OP}	-40 to +85	°C		
Storage Temperature Range		T _{STG}	-55 to +150	°C	
Junction Temperature	TJ	+125	°C		

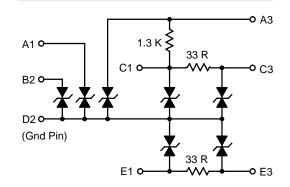
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

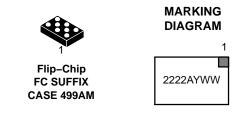
*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



ON Semiconductor®

http://onsemi.com

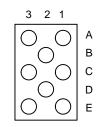




2222	= Specific Device Code
А	= Assembly Location
Y	= Year

WW = Work Week

PIN CONFIGURATION



ORDERING INFORMATION

Device	Package	Shipping†	
NUF2222FCT1G	Flip–Chip	3000 Tape & Reel	

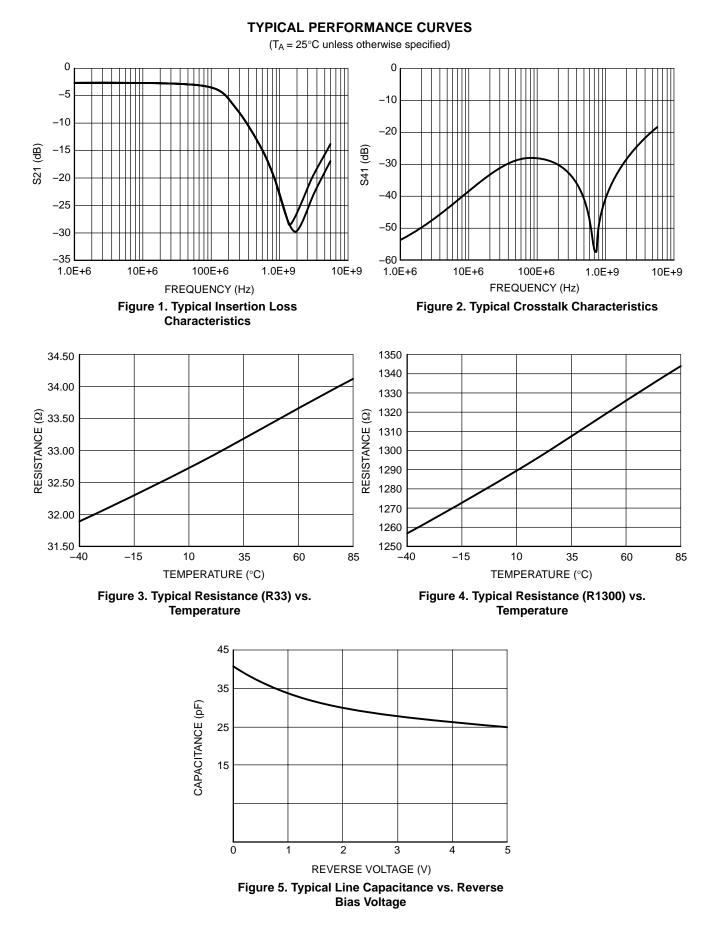
⁺For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NUF2222FC

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Test Conditions	Min	Тур	Max	Unit
Maximum Reverse Working Voltage	V _{RWM}	-	-	-	5.6	V
Breakdown Voltage	V _{BR}	I _R = 1.0 mA	6.0	-	8.8	V
Leakage Current	I _R	V _{RWM} = 3.3 V	-	1.0	100	nA
Pull Up Resistance	R _{pu}	-	1.1	1.3	1.5	kΩ
Series Resistance	R _S	-	28	33	38	Ω
Capacitance	C _{LINE}	f = 1.0 MHz, 0 Vdc	-	36	40	pF
$\label{eq:cut-Off} \mbox{Cut-Off Frequency} \qquad f_{3dB} \qquad 50 \ \Omega \ \mbox{Source and } 50 \ Source an$		50 Ω Source and 50 Ω Load Termination	-	190	-	MHz

NUF2222FC



NUF2222FC

PRINTED CIRCUIT BOARD RECOMMENDATIONS

Parameter	500 μm Pitch 300 or 350 μm Solder Ball
PCB Pad Size	250 μm +25 -0
Pad Shape	Round
Pad Type	NSMD
Solder Mask Opening	350 μm ±25
Solder Stencil Thickness	125 μm
Stencil Aperture	250 x 250 μm sq.
Solder Flux Ratio	50/50
Solder Paste Type	No Clean Type 3 or Finer
Trace Finish	OSP Cu
Trace Width	150 μm Max

Copper

Solder mask



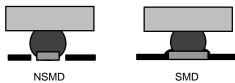
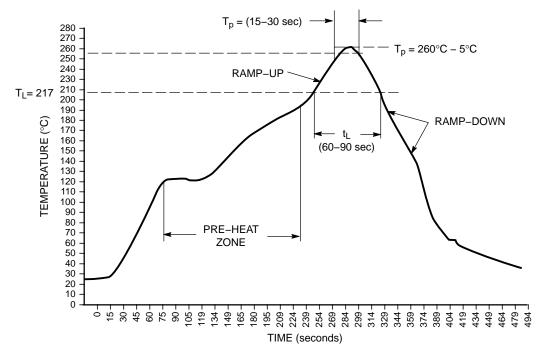


Figure 6. NSMD vs. SMD





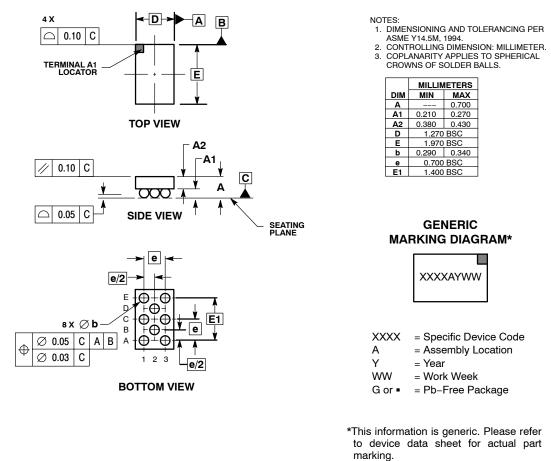
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SCALE 4:1

8 PIN FLIP-CHIP CASE 499AM ISSUE O

DATE 17 FEB 2005



Pb-Free indicator, "G" or microdot " •", may or may not be present.

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DESCRIPTION:	DESCRIPTION: 8 PIN FLIP-CHIP, 1.970*1.270,, 0.700 LEAD PITCH		PAGE 1 OF 1		
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